







		I			2			3			4		
	PRODUCT NUMBER	SOLDER BALI	COMPOS	ITION	CONTACT	PLATING	PERFORMANCE	LEVEL		I			
	10097161-001	STANDARD	(EUTECT	IC)	PERFORMANCE - E								
	10097161-001LF	LEAI	DFREE		THE REQUIREME GS-12-192,INC	LUDING TE	LCORDIA CEN	TRAL OFF	ICE				
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~	NOTE	S :											~
ight FCI.	<ul> <li>2</li> <li>3</li> <li>4</li> <li>5</li> </ul>	SOLDER BALLS SHPERICAL SH MATED HEIGH PCB PAD SIZE PROFILE & SC CONTACTS IN ARE SINGLE E TYPICALLY US (NOTE: CONTA	COPPER AL ONTACT): 94 V-C (SEE T AD FREE S WILL NO HAPE DUE T EFFECTE C, PLATIN DLDER PAS ROWS A,C BEAM CONT SED AS GR ACTS IN R OGETHER ROWS B,E	AU OVI ABLE) I 95.5 S DT BE P TO REFI ED BY C G, SOLI TE. C,E,G,J ACTS, OUND P OWS J ICOMMOI O,F,H,L TS,	EUTECTIC n/4Ag/0.5Cu. ERFECT LOW ATTACHMENT. USTOMERS ' DER REFLOW ,K,M,P,R AND T INS. & K ARE NEDJ) ,N,Q AND S	OF SH PR DO T SP NO DU PR WI RE 8. TH DI RE PR IN MA AN	LAND PATTERN ALL BE DEFINED ODUCT APPLICAT C. NO. GS-20-0 R PROPER APPLI	TO FUDICIAL BY CUSTOMEF ION AND PCB IG. CATION FOLLO -20-033. LEA REFLOW TEMPE FORE NOT BAC OME SOLDERIN PLICATION SF TS THE EUROF DTHER COUNTF ESCRIBED IN THIS DIRECT I HE CODE NUME ART BY HAVIN	MARKS OR R. FOR RE DESIGN DE AD FREE SCO AD FREE SCO ERATURE. L CKWARDS CC NG APPLICA PECIFICATI PEAN UNION RY GS-22-008 IVE IS BER NG	COMMENDED TAILS, SEE PLICATION DEDER BALLS WILL ER PROCESS EADFREE MMPATIBLE ATIONS. ION.			B C
Copyr	spec ref tolerance ASME YI	, TOLEF	ANCES U			2010/11/0 2011/05/3 2011/06/2	4	projection		mm	size A 4 ecn no	scale   : 0 ELX-DG-003943-1	D
U	- surface	Linear	0.X 0.XX	±0.30 ±0.10		2011/06/2 5 mm R	ECEPTAC	LE AS	,	GIG-Array දි ත	rel level	Released rev	υ
			0.XXX	$\pm 0.05$			i. POS. WI					B	
		angular	0°	±2°	www.fci.com	at. no.		*	Prod	luct – Customei	Drw she	et 5 of 5	
			I		2		I	3	PDS:	Rev :B STA	TUS:Released F	Printed: Jun 27, 201	1